# 1-316130-2 - ACTIVE

#### Dynamic Series | Dynamic 3000 Series

TE Internal #: 1-316130-2 PCB Mount Header, Horizontal, Wire-to-Board, 5 Position, 5.08 mm [.2 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 3000 Series

#### View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 15A, gold or tin plated



Connector System: Wire-to-Board

Number of Positions: 5

Number of Rows: 1

Centerline (Pitch): 5.08 mm [.2 in ]

PCB Mount Orientation: Horizontal

#### All Header Assembly: Wire-to-Board, 15A, gold or tin plated (134)



### Features

#### Product Type Features

Connector System	Wire-to-Board				
Header Type	Fully Shrouded				
Sealable	No				
Connector & Contact Terminates To	Printed Circuit Board				
PCB Connector Assembly Type	PCB Mount Header				
Configuration Features					
Number of Positions	5				
Number of Rows	1				
PCB Mount Orientation	Horizontal				
Body Features					
Primary Product Color	Black				
Contact Features					

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Contact Mating Area Plating Material Thickness	.38 μm[15 μin]			
Contact Mating Area Plating Material	Gold			
Contact Type	Pin			
Contact Current Rating (Max)	15 A			
Termination Features				
Termination Method to Printed Circuit Board	Through Hole - Solder			
Mechanical Attachment				
Mating Alignment Type	Keyed			
Mating Retention	With			
PCB Mount Retention Type	Retention Leg			
Connector Mounting Type	Board Mount			
Mating Alignment	With			
PCB Mount Alignment	Without			
PCB Mount Retention	With			
Housing Features				
Housing Material	Polyester GF			
Centerline (Pitch)	5.08 mm[.2 in]			

## Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]				
Operation/Application					
Circuit Application	Power & Signal				
Industry Standards					
UL Flammability Rating	UL 94V-0				
Packaging Features					
Packaging Type	Box, Tube				
Product Compliance					
For compliance documentation, visit the product page on TE.com>					
EU RoHS Directive 2011/65/EU	Compliant				
EU ELV Directive 2000/53/EC	Compliant				
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold				
EU REACH Regulation (EC) No. 1907/2006					

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Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC

Not Low Halogen - contains Br or Cl > 900 ppm.

Wave solder capable to 265°C

Halogen Content

Solder Process Capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**



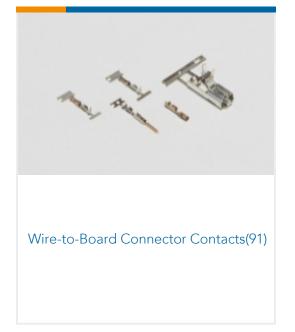
## Also in the Series | Dynamic 3000 Series



PCB Mount Header, Horizontal, Wire-to-Board, 5 Position, 5.08 mm [.2 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 3000 Series







## Customers Also Bought



TE Part #2-178139-2 Header Assembly: Wire-to-Board, 15A, gold or tin plated	TE Part #1376020-1 DYNAMIC D2100 HDR H ASSY 12P X	TE Part #1-178141-2 DYNAMIC CONN 6P V HDR ASSY	TE Part #3-16259 HSA50 24R 5%
	ETE		
TE Part #1888631-1 Cage Assy PCI Hsink QSFP Thru	TE Part #2-1318983-2 DYNAMIC D-5200M ALPHA HDR ASSY 4P YY AU	TE Part #4-2170747-4 CAGE ASSY, 1X4, QSFP28, SPRING, HS, LP	

## Documents

Product Drawings DYNAMIC D-3200 HDR ASSY 5P H

English

#### **CAD** Files

**Customer View Model** 

ENG\_CVM\_1-316130-2\_B.3d\_igs.zip

English

Customer View Model

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ENG\_CVM\_1-316130-2\_B.3d\_stp.zip

English

Customer View Model

ENG\_CVM\_1-316130-2\_B.2d\_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages 1-1773732-4\_DYNAMIC\_SERIES\_CATALOG\_ENGLISH

Japanese

1-1773732-4\_DYNAMIC\_SERIES\_CATALOG\_ENGLISH

English

**Product Specifications** 

**Product Specification** 

English

Agency Approvals TUV Certificate

English